

Intensity						
50% Power Viewing Angle	20½	IF = 20mA	---	40	---	deg
■ Absolute Maximum Ratings at (Ta = 25°C)						
ITEMS	SYMBOL	ABSOLUTE MAXIMUM RATING			UNIT	
Forward Current	IF	50			mA	
Peak Forward Current	IFP	220			mA	
Continuous Forward Current	IL	20			mA	
Reverse Voltage	VR	5			V	
Power Dissipation	PD	95			mW	
Operation Temperature	Topr	-40 ~ +80			°C	
Storage Temperature	Tstg	-40 ~ +80			°C	
Lead Soldering Temperature	Tsol	Max.260°C for 5 sec Max.				

IFP Conditions: Pulse Width ≤ 10msec duty ≤ 1/10

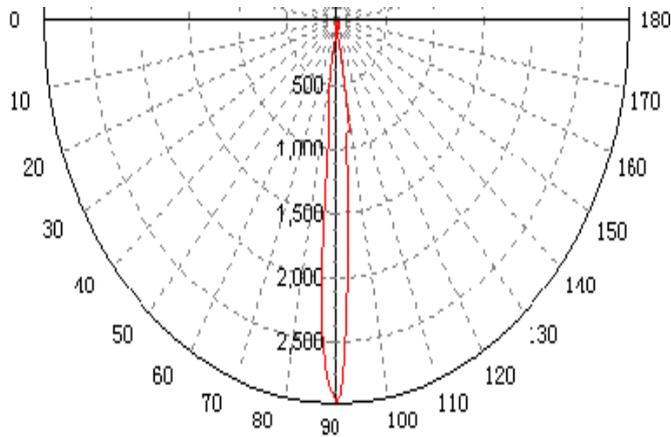
Tsol Conditions: 4mm from the base of the epoxy bulb



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Model: 5AY3UD09

■ Spatial Distribution



■ Reliability Performance

Test Classification	Test Item	Test Conditions	Test Duration	Sample Size	Standard
Life Test	Life Test	Ta=25°C±5°C, IF=20mA	1000(hrs)	10PCS	
	Thermal Shock	-10°C±5°C ↔ +100°C±5°C		10PCS	

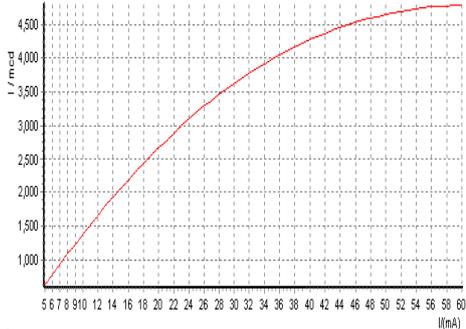
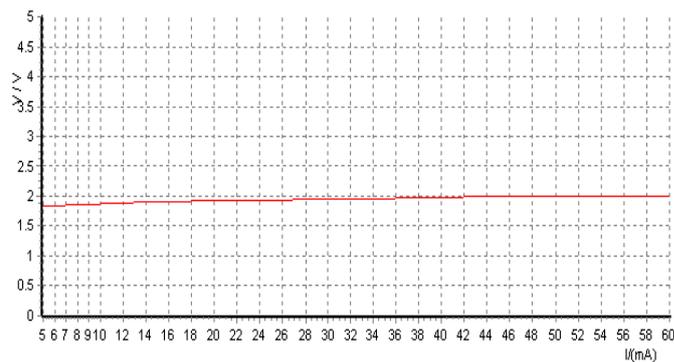
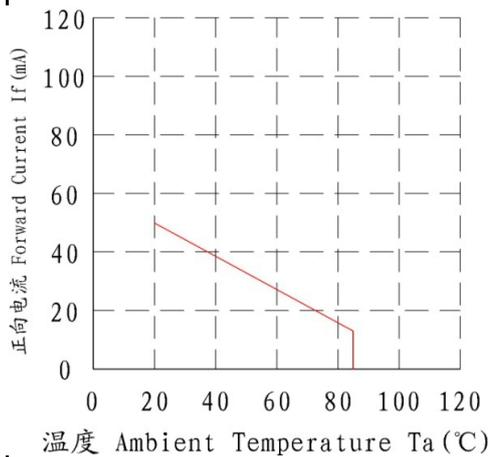
Environment Test	Test	5min. 10sec. 5min.	100(cycles)	10PCS	
	Temperature Cycle Test	-55°C±5°C←→+85°C±5°C 30min. 5min. 30min.	100(cycles)	10PCS	
	High Temperature & High Humidity Test	Ta=85°C±5°C RH =85%±0.5 %RH	240(hrs)	10PCS	
	High Temperature	Ta=100°C±5°C	1000(hrs)	10PCS	
	Low Temperature Storage	Ta=-55°C±5°C	1000(hrs)	10PCS	
Mechanical Test	Resistance to Soldering Heat	Ta=260°C±5°C	5 (sec.)	10PCS	
	Lead Integrity	负荷2.5 牛顿(0.25 千克) 0° ~ 90° ~ 0°	3 (times)	10PCS	



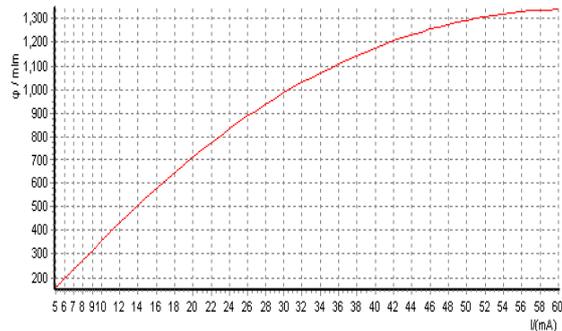
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■ Typical Optical/Electrical Characteristics Curves (Ta=25°C Unless Otherwise Noted)

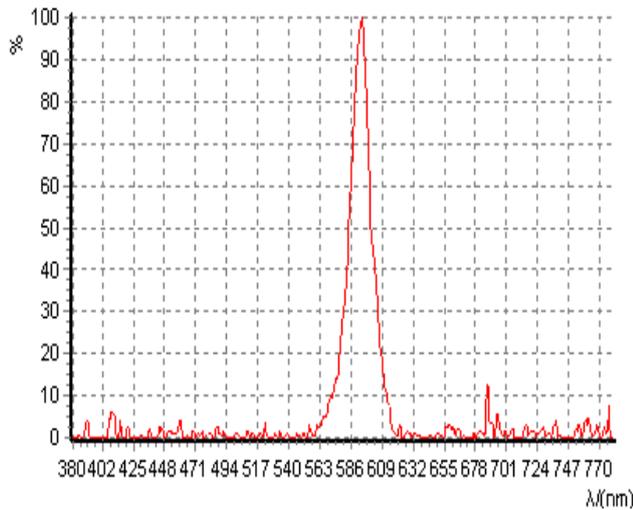


Current-Voltage Curve



Current-Luminous intensity Curve

Current-Luminous flux Curve



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1.Application

- A.Office equipment & Communications equipment & Home decoration
- B.Traffic control & Medical equipment & Air transport

2.Storage

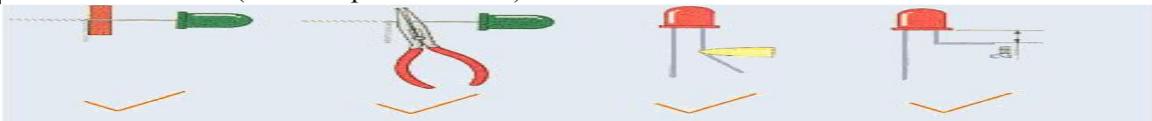
- A.Temperature $\leq 30^{\circ}\text{C}$
- B.Relative Humidity: $\leq 70\%$
- C.Usage Time in Packing Container ≤ 3 months
- D.Long-Time Storage Condition:Drying Cabinet(with desiccant or Nitrogen)

3.Wash

- A.Use alcohol to wipe LED Lampes,Washing Time ≤ 3 minutes(at normal temperature)
- B.Notice:Be careful about washing colloid by chemical goods.Such as:

4.Pins Fitting

- (1) Must be 2 mm from the colloid to bend the stent.
- (2) Stent forming must be done by a fixture or by a professional.
- (3) Support must be completed before welding.
- (4) Support is required to ensure that the pin and spacing are consistent with the circuit
- (5) Welding must be carried out at normal temperature, and when the LED is normally welded to the PCB board. the mechanical pressure should be applied to the LED pin as Bend stent $\geq 2\text{mm}$ (between pins & colloid)



5.Soldering

- A.Soldering under 2mm
- B.Avoid dipping and shaking colloid

Recommended soldering conditions	
Soldering iron	Wave soldering
Welding	Desoldering

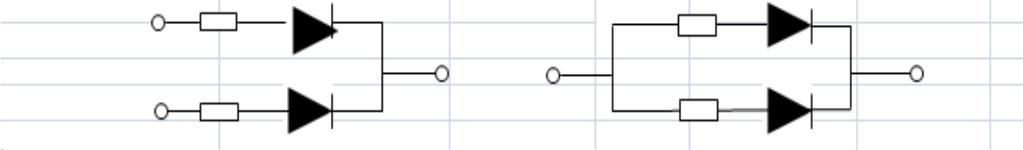
welding temperature	260℃ Max	Preheating temperature	100℃ Max
Welding time	5 Sec.Max (one time only)	Warm-up time	60sec.Max
		Welding temperature	260℃.Max
		Welding time	10sec.Max

Excessive welding temperature and long welding time will lead to led change and deformation

6. Driving way

Circuit model A (many led lamps in parallel)

Circuit model B



7. Electrostatic Protection

A. Use anti-static device. Such as: shield and gloves

B. HBM < 1000V Machine Discharge Model < 100V